

Overvoltage Protection Controllers with Reverse Polarity Protection

ABSOLUTE MAXIMUM RATINGS

IN to GND	-0.3V to +30V
GATEN, GATEP to GND	-0.3V to +12V
IN to GATEP	-0.3V to +20V
FLAG, $\overline{\text{EN}}$ to GND	-0.3V to +6V
Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)	
6-Pin μDFN (2mm x 2mm) (derate 2.1mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	168mW
6-Pin SOT23 (derate 8.7mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	696mW

Operating Temperature Range	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+240°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{\text{IN}} = +5\text{V}$ (MAX4864L/MAX4865L/MAX4866L), $V_{\text{IN}} = +4\text{V}$ (MAX4867), $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, $C_{\text{GATEN}} = 500\text{pF}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Voltage Range	V _{IN}			1.2		28.0	V
Overvoltage Trip Level	OVLO	V _{IN} rising	MAX4864L	7.0	7.4	7.8	V
			MAX4865L	5.95	6.35	6.75	
			MAX4866L	5.45	5.8	6.15	
			MAX4867	4.35	4.65	4.95	
Overvoltage Lockout Hysteresis		MAX4864L		75			mV
		MAX4865L		65			
		MAX4866L		55			
		MAX4867		50			
Undervoltage Lockout Threshold	UVLO	V _{IN} falling	MAX4864L/MAX4865L/MAX4866L	2.65	2.85	3.05	V
			MAX4867	2.3	2.5	2.7	
Undervoltage Lockout Hysteresis		MAX4864L/MAX4865L/MAX4866L		44			mV
		MAX4867		25			
IN Supply Current	I _{IN}	$\overline{\text{EN}}$ = GND	MAX4864L/MAX4865L/MAX4866L	77		120	μA
			MAX4867	68		110	
UVLO Supply Current	I _{UVLO}	$\overline{\text{EN}}$ = GND	MAX4864L/MAX4865L/MAX4866L, V _{IN} = +2.6V	8.5		22	μA
			MAX4867, V _{IN} = +2.2V	8		18	
Shutdown Supply Current	I _{SHD}	$\overline{\text{EN}}$ = 1.6V	MAX4864L/MAX4865L/MAX4866L, V _{IN} = 3.6V	0.4		2	μA
			MAX4867, V _{IN} = 3.6V	0.4		2	
GATEN Voltage	V _{GATEN}	1μA load	MAX4864L/MAX4865L/MAX4866L	9	9.83	10	V
			MAX4867	7.5	7.85	8.0	
GATEN Pulldown Current	I _{PD}	V _{IN} > OVLO, V _{GATEN} = +5.5V		12	32	65	mA
GATEP Clamp Voltage	V _{CLAMP}			13.5	16.5	19.5	V
GATEP Pulldown Resistor	R _{GATEP}			32	48	64	kΩ
FLAG Output-Low Voltage	V _{OL}	I _{SINK} = 1mA				0.4	V
FLAG Leakage Current		V _{FLAG} = +5.5V		1			μA
$\overline{\text{EN}}$ Input-High Voltage	V _{IH}			1.5			V
$\overline{\text{EN}}$ Input-Low Voltage	V _{IL}			0.4			V

Overvoltage Protection Controllers with Reverse Polarity Protection

MAX4864L/MAX4865L/MAX4866L/MAX4867

ELECTRICAL CHARACTERISTICS (continued)

($V_{IN} = +5V$ (MAX4864L/MAX4865L/MAX4866L), $V_{IN} = +4V$ (MAX4867), $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, $C_{GATEN} = 500\text{pF}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
$\overline{\text{EN}}$ Input Leakage Current	I_{LKG}	$\overline{\text{EN}} = \text{GND}$ or $+5.5V$			1	μA
TIMING						
Startup Delay	t_{START}	$V_{IN} > \text{UVLO}$ to $V_{\text{GATEN}} > 0.3V$, Figure 1	20	50	80	ms
FLAG Blanking Time	t_{BLANK}	$V_{\text{GATEN}} > 0.3V$ to $V_{\text{FLAG}} < 0.3V$, Figure 1	20	50	80	ms
GATEN Turn-On Time	t_{GON}	$C_{\text{GATEN}} = 500\text{pF}$, $V_{\text{GATEN}} = 0.3V$ to $+8V$ (MAX4864L/MAX4865L/MAX4866L) $V_{\text{GATEN}} = 0.3V$ to $+7V$ (MAX4867), Figure 1		10		ms
GATEN Turn-Off Time	t_{GOFF}	V_{IN} rising at $3V/\mu\text{s}$ from $+5V$ to $+8V$ (MAX4864L/MAX4865L/MAX4866L), or from $+4V$ to $+7V$ (MAX4867) $V_{\text{GATEN}} = 0.3V$, $C_{\text{GATEN}} = 500\text{pF}$, Figure 2		7	20	μs
FLAG Assertion Delay	t_{FLAG}	V_{IN} rising at $3V/\mu\text{s}$ from $5V$ to $8V$ (MAX4864L/MAX4865L/MAX4866L), or from $+4V$ to $+7V$ (MAX4867), $V_{\text{FLAG}} = 0.3V$, Figure 2		3.5		μs
Initial Overvoltage Fault Delay	t_{OVP}	V_{IN} rising at $3V/\mu\text{s}$ from $0V$ to $+9V$, time from $V_{IN} = 5V$ to $I_{\text{GATEN}} = 80\%$ of I_{PD} (GATEN pulldown current), Figure 3		1.5		μs
Disable Time	t_{DIS}	$\overline{\text{VEN}} = +2.4V$, $V_{\text{GATEN}} = 0.3V$, Figure 4		2		μs

Note 1: All parts are 100% tested at $+25^\circ\text{C}$. Electrical limits across the full temperature range are guaranteed by design and correlation.

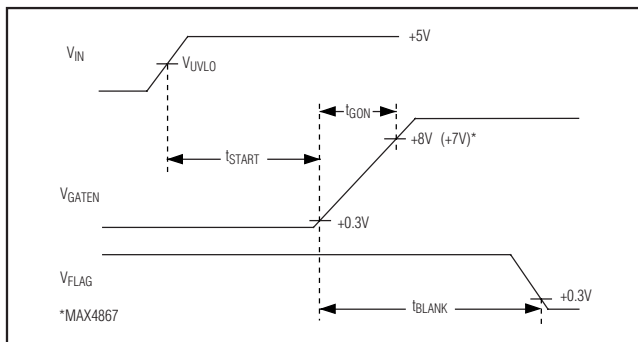


Figure 1. Startup Timing Diagram

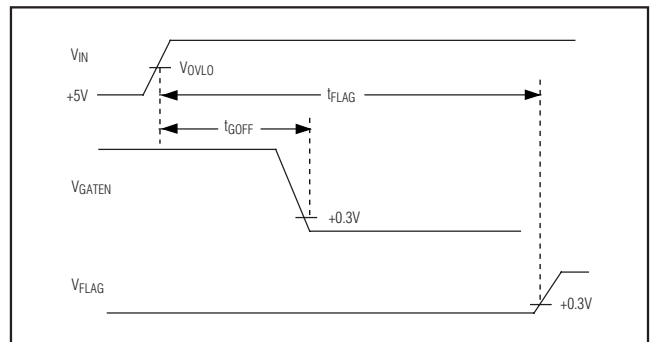


Figure 2. Shutdown Timing Diagram

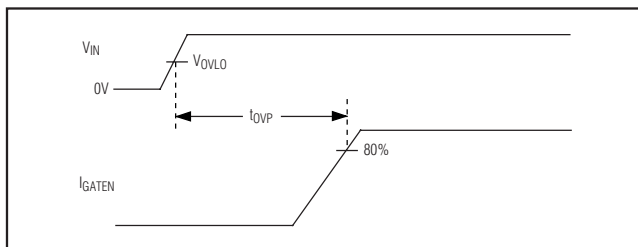


Figure 3. Power-Up Overvoltage Timing Diagram

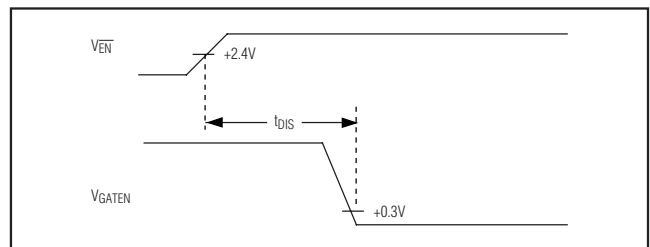


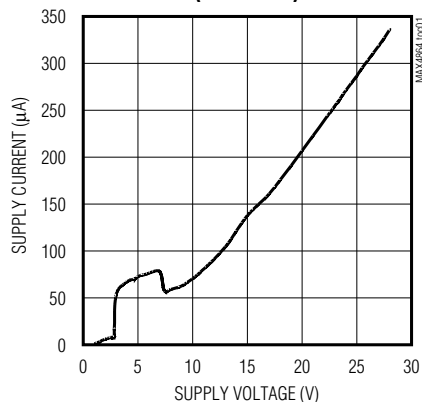
Figure 4. Disable Timing Diagram

Overvoltage Protection Controllers with Reverse Polarity Protection

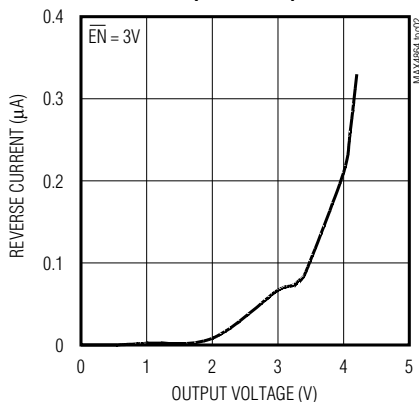
Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

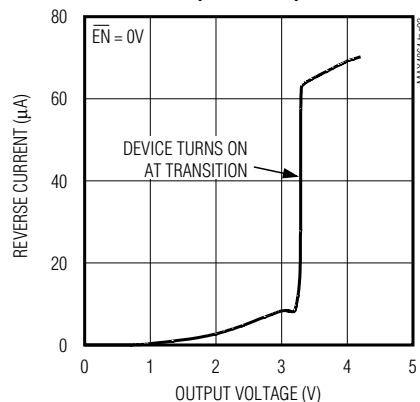
SUPPLY CURRENT vs. SUPPLY VOLTAGE (MAX4864L)



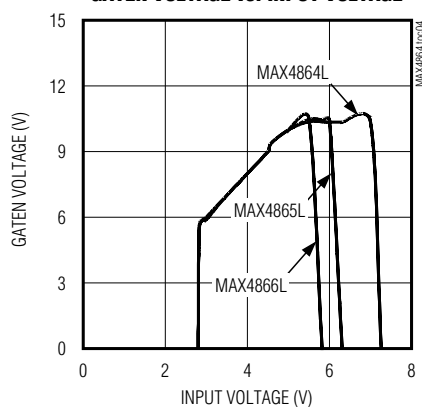
REVERSE CURRENT vs. OUTPUT VOLTAGE (MAX4864L)



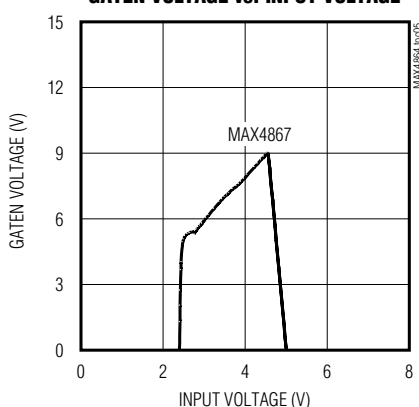
REVERSE CURRENT vs. OUTPUT VOLTAGE (MAX4864L)



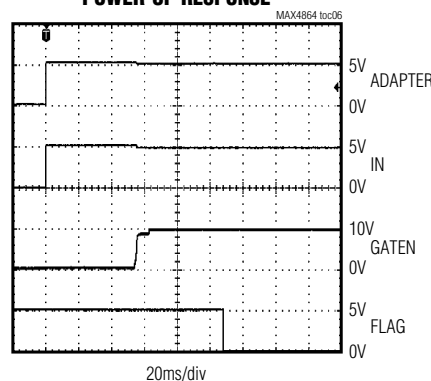
MAX4864L/MAX4865L/MAX4866L GATEN VOLTAGE vs. INPUT VOLTAGE



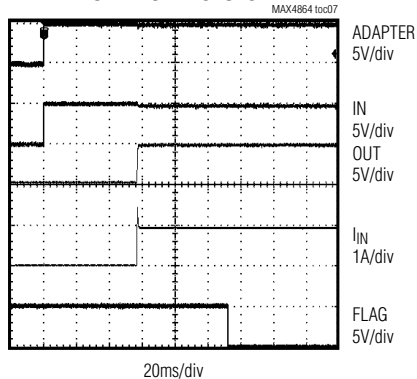
MAX4867 GATEN VOLTAGE vs. INPUT VOLTAGE



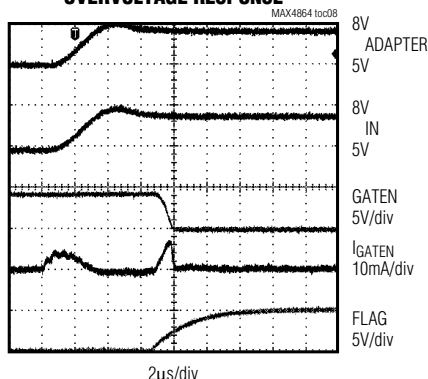
POWER-UP RESPONSE



POWER-UP RESPONSE



OVERVOLTAGE RESPONSE

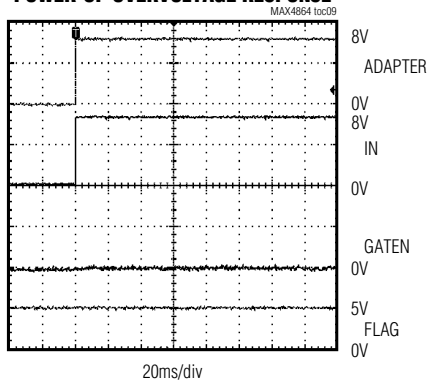


Overvoltage Protection Controllers with Reverse Polarity Protection

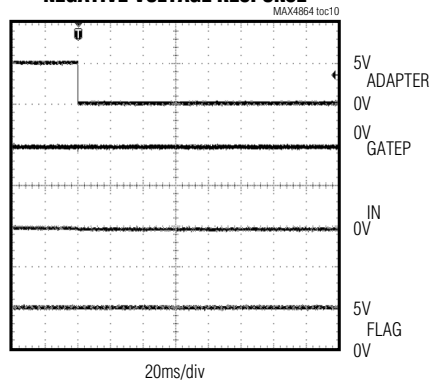
Typical Operating Characteristics (continued)

(T_A = +25°C, unless otherwise noted.)

POWER-UP OVERVOLTAGE RESPONSE



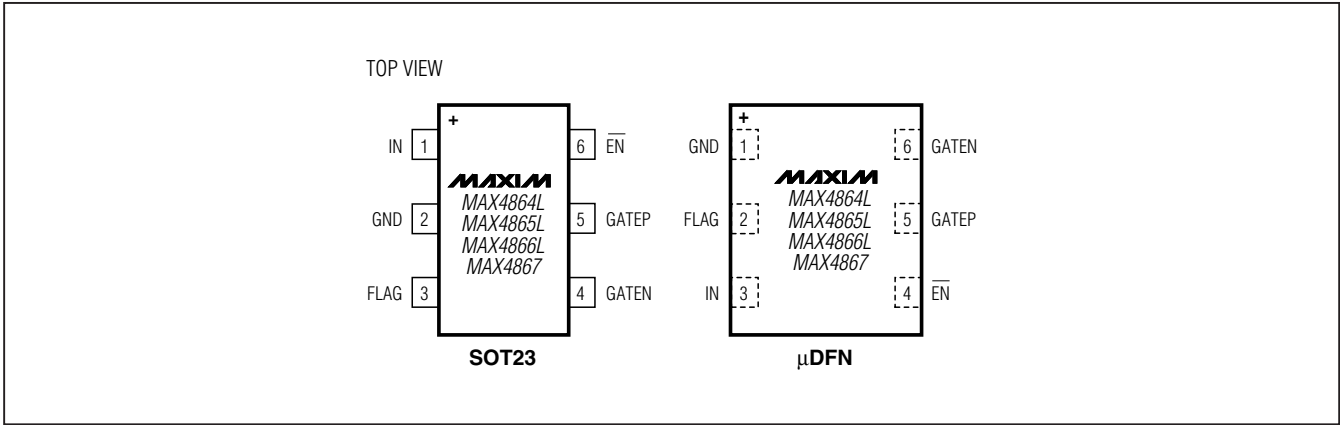
NEGATIVE VOLTAGE RESPONSE



MAX4864L/MAX4865L/MAX4866L/MAX4867

Overvoltage Protection Controllers with Reverse Polarity Protection

Pin Configuration



Pin Description

PIN		NAME	FUNCTION
MAX4864LEUT/ MAX4865LEUT/ MAX4866LEUT/ MAX4867EUT	MAX4864LELT/ MAX4865LELT/ MAX4866LELT/ MAX4867ELT		
1	3	IN	Voltage Input. IN is both the power-supply input and the overvoltage sense input.
2	1	GND	Ground
3	2	FLAG	Fault-Indication Output. When $\overline{\text{EN}}$ goes high, FLAG becomes high-impedance. FLAG is asserted high during undervoltage lockout and overvoltage lockout conditions. FLAG is deasserted during normal operation. FLAG is an open-drain output.
4	6	GATEN	n-Channel MOSFET Gate-Drive Output. GATEN is the output of an on-chip charge pump. When $V_{\text{UVLO}} < V_{\text{IN}} < V_{\text{OVLO}}$, GATEN is driven high to turn on the external n-channel MOSFET.
5	5	GATEP	p-Channel MOSFET Gate-Drive Output. GATEP is always on when input is above ground and off when input drops below ground.
6	4	$\overline{\text{EN}}$	Active-Low Enable Input. Connect to ground in normal operation. Drive $\overline{\text{EN}}$ high to disable device and enter shutdown mode.

Overvoltage Protection Controllers with Reverse Polarity Protection

Detailed Description

The MAX4864L/MAX4865L/MAX4866L/MAX4867 provide up to +28V overvoltage and negative voltage protection for low voltage systems. When the input voltage exceeds the overvoltage trip level, the MAX4864L/MAX4865L/MAX4866L/MAX4867 turn off a low-cost external n-channel MOSFET to prevent damage to the protected components. The devices also drive an external p-channel MOSFET to protect against negative voltage inputs. An internal charge-pump (see the *Functional Diagram*), drives the MOSFET GATEN for a simple, robust solution. On power-up, the device waits for 50ms before driving GATEN high. The open-drain FLAG output is kept at a high impedance for an additional 50ms after GATEN goes high before deasserting. The FLAG output asserts high immediately to an overvoltage fault.

Undervoltage Lockout (UVLO)

The MAX4864L/MAX4865L/MAX4866L have a fixed +2.85V typical UVLO level, and the MAX4867 has +2.5V UVLO level. When V_{IN} is less than the UVLO, the GATEN driver is held low and FLAG is asserted.

Overvoltage Lockout (OVLO)

The MAX4864L has a +7.4V typical OVLO threshold; the MAX4865L has +6.35V typical OVLO threshold; the MAX4866L has a +5.8V typical OVLO threshold; and the MAX4867 has a +4.65V typical OVLO threshold. When V_{IN} is greater than OVLO, the GATEN driver is held low and FLAG is asserted.

FLAG Output

The open-drain FLAG output is used to signal to the host system when there is a fault with the input voltage. On power-up, FLAG is held high for 50ms after GATEN turns on, before deasserting. FLAG asserts immediately to overvoltage and undervoltage faults. When the fault condition is removed, FLAG deasserts 50ms after GATEN turns on. Connect a pullup resistor from FLAG to the logic I/O voltage of the host system.

GATEN Driver

An on-chip charge pump is used to drive GATEN above IN, allowing the use of a low-cost n-channel MOSFET. The charge pump operates from the internal +5.5V regulator.

The actual GATEN output voltage tracks approximately two times V_{IN} until V_{IN} exceeds +5.5V, or the OVLO trip level is exceeded, whichever comes first. The MAX4864L has a +7.4V typical OVLO, therefore GATEN remains relatively constant at approximately +10.5V for $+5.5V < V_{IN} < +7.4V$. The MAX4866L has a +5.8V typical OVLO, but this can be as low as +5.5V. The GATEN

output voltage is a function of input voltage, as shown in the *Typical Operating Characteristics*.

GATEP Driver

When the input voltage drops below ground, GATEP goes high turning the external p-channel MOSFET off. When the input voltage goes above ground, GATEP pulls low and turns on the p-channel MOSFET. An internal clamp protects the p-channel MOSFET by insuring that the GATEP-to-IN voltage does not exceed +16V when the input (IN) rises to +28V.

Device Operation

The MAX4864L/MAX4865L/MAX4866L/MAX4867 have an on-board state machine to control device operation. A flowchart is shown in Figure 5. On initial power-up, if $V_{IN} < UVLO$ or if $V_{IN} > OVLO$, GATEN is held at 0V and FLAG is high.

If $UVLO < V_{IN} < OVLO$, the device enters startup after a 50ms internal delay. The internal charge pump is enabled, and GATEN begins to be driven above V_{IN} by the internal charge pump. FLAG is held high during startup until the FLAG blanking period expires, typically 50ms after the GATEN starts going high. At this point, the device is in its on-state.

At any time if V_{IN} drops below UVLO, FLAG is driven high and GATEN is driven to ground.

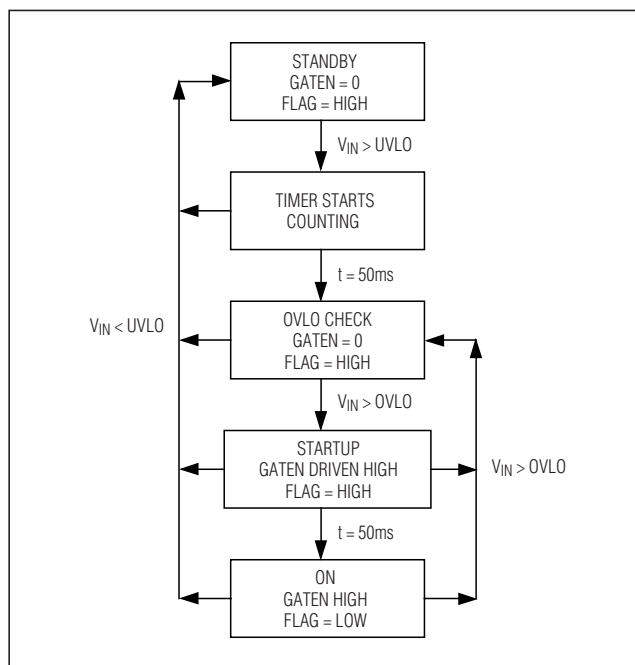


Figure 5. State Diagram

Figure 6. Back-to-Back External MOSFET Configuration

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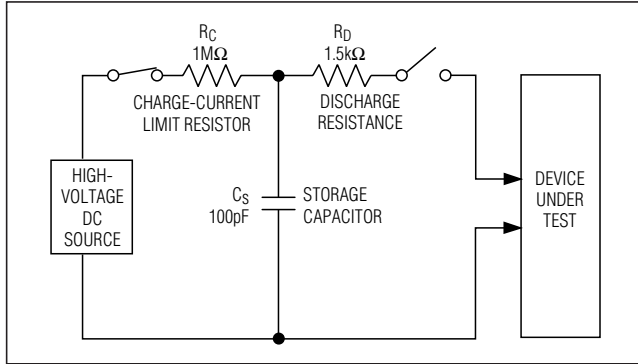


Figure 7. Human Body ESD Test Model

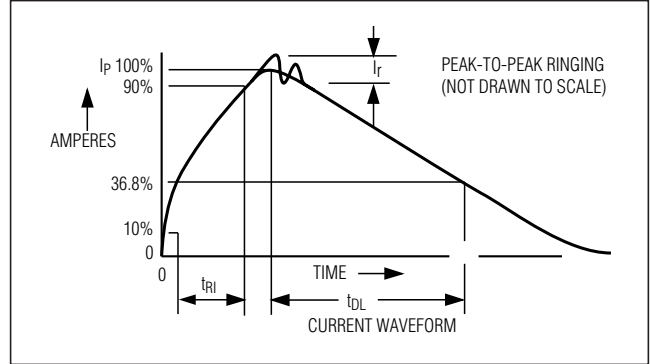


Figure 8. Human Body Current Waveform

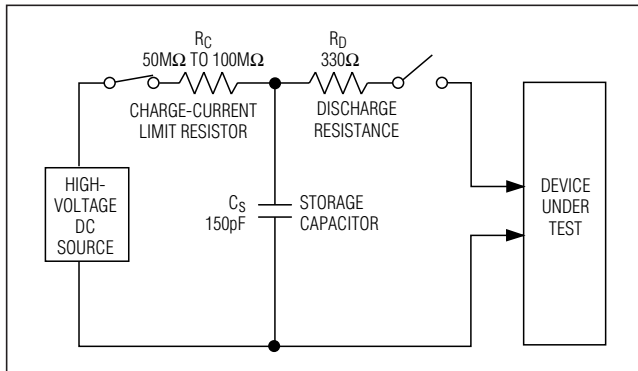


Figure 9. IEC 1000-4-2 ESD Test Model

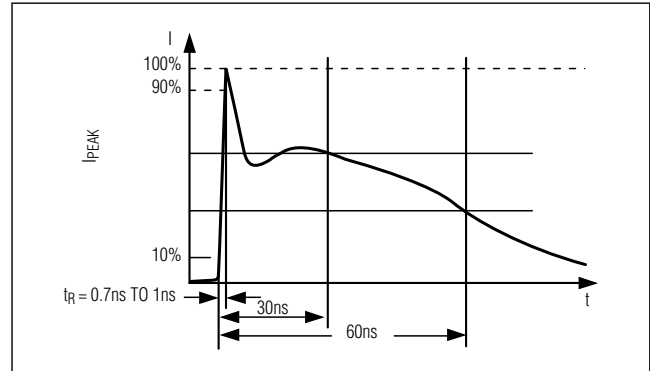


Figure 10. IEC 1000-4-2 ESD Generator Current Waveform

IEC 1000-4-2

Since January 1996, all equipment manufactured and/or sold in the European Union has been required to meet the stringent IEC 1000-4-2 specification. The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment. It does not specifically refer to ICs. The MAX4864L/MAX4865L/MAX4866L/MAX4867 help users design equipment that meets Level 3 of IEC 1000-4-2, without additional ESD-protection components.

The main difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2. Because series resistance is lower in the IEC 1000-4-2 ESD test model (Figure 9), the ESD-withstand voltage measured to this standard is gen-

erally lower than that measured using the Human Body Model. Figure 10 shows the current waveform for the $\pm 8\text{kV}$ IEC 1000-4-2 Level 4 ESD Contact Discharge test. The Air-Gap test involves approaching the device with a charger probe. The Contact Discharge method connects the probe to the device before the probe is energized.

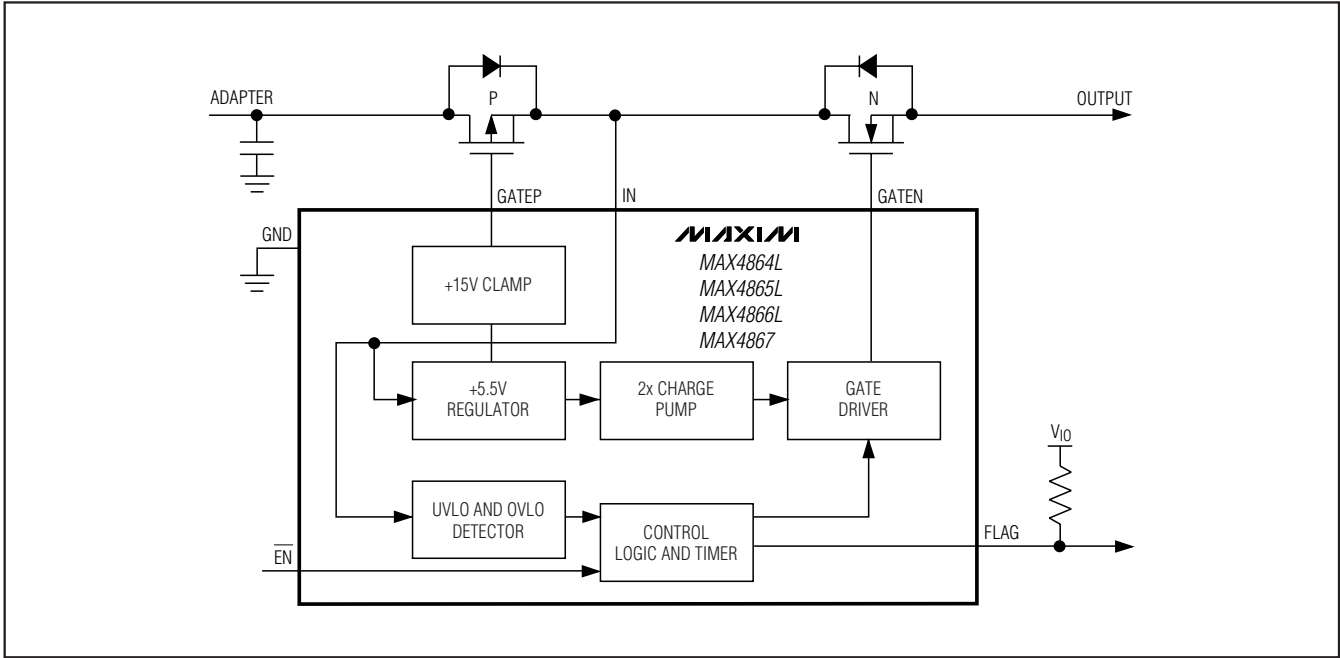
Chip Information

PROCESS: BiCMOS

MAX4864L/MAX4865L/MAX4866L/MAX4867

Overvoltage Protection Controllers with Reverse Polarity Protection

Functional Diagram



Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
6 μ DFN	L622-1	21-0164
6 SOT23	U6-1	21-0058

Overvoltage Protection Controllers with Reverse Polarity Protection

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	5/10	Deleted package codes from the <i>Ordering Information</i> table; updated the <i>Pin Configuration</i> , Figure 7, and Figure 9; deleted the transistor count from the <i>Chip Information</i> section	1, 6, 9, 10

MAX4864L/MAX4865L/MAX4866L/MAX4867

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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